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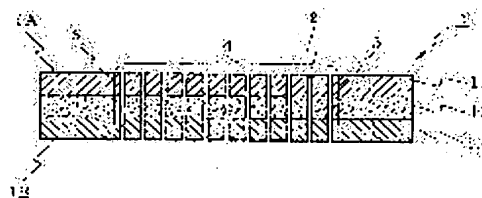
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(54) METHOD FOR MANUFACTURING PRESSURE -SENSITIVE ADHESIVE SHEET AND PRESSURE -SENSITIVE ADHESIVE SHEET

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a pressure-sensitive adhesive sheet which secures sufficient adhesive force without adversely affecting the external appearance of the pressure-sensitive adhesive sheet and can prevent or remove trapped air or a blister, and a method for manufacturing such a pressure-sensitive adhesive.

SOLUTION: The method for manufacturing the pressure-sensitive adhesive sheet comprises laminating a base material 11, a pressure-sensitive adhesive layer 12, and a releasing material 13 and forming penetrating holes only in a predetermined area (a label portion 4) of the laminated sheet so as for the penetrating holes in the base material 11 and the pressure-sensitive adhesive layer 12 having a hole diameter of 0.1-300 μm to have a hole density in the predetermined area (a label portion 4) of 30-50,000/100 cm^2 . The penetrating holes 2 are preferably formed by laser processing.



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